

# SN54265, SN74265 QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

SDLS088

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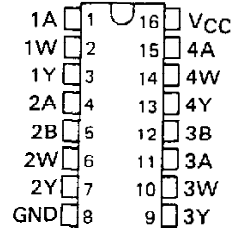
## FOR SYMMETRICAL GENERATION OF COMPLEMENTARY TTL SIGNALS

- Switching Time Skew of the Complementary Outputs is Typically 0.5 ns . . . Not More than 3 ns at Rated Loading
- Full Fan-Out to 20 High-Level and 10 Low-Level 54/74 Loads
- Active Pull-Down Provides Square Transfer Characteristics

SN54265 . . . J OR W PACKAGE

SN74265 . . . N PACKAGE

(TOP VIEW)



NC - No internal connection

### description

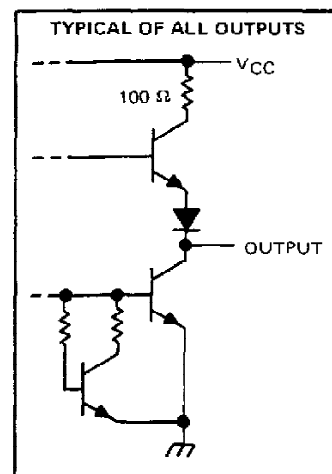
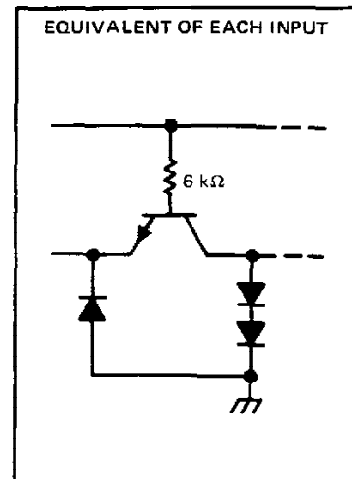
The SN54265 and SN74265 circuits feature complementary outputs from each logic element, which have virtually symmetrical switching time delays from the triggering input. They are designed specifically for use in applications such as:

- Symmetrical clock/clock generators
- Complementary input circuit for decoders and code converters
- Switch debouncing
- Differential line driver

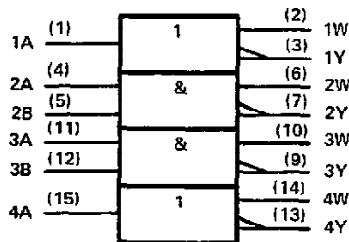
Examples of these four functions are illustrated in the typical application data.

The SN54265 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ; the SN74265 is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

### schematics of inputs and outputs



### logic symbol†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

### logic diagrams

ELEMENTS 1 and 4



ELEMENTS 2 and 3



### positive logic

$$Y = \bar{A} \quad W = A$$

$$Y = \bar{A}\bar{B} \text{ or } Y = \bar{A} + \bar{B}$$

$$W = AB \text{ or } W = \bar{A} + \bar{B}$$

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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## SN54265, SN74265 QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN54265	$-55^{\circ}\text{C}$ to $125^{\circ}\text{C}$
SN74265	$0^{\circ}\text{C}$ to $70^{\circ}\text{C}$
Storage temperature range	$-65^{\circ}\text{C}$ to $150^{\circ}\text{C}$

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54265			SN74265			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$	4.5	5	5.5	4.75	5	5.25	V
High-level output current, $I_{OH}$			-800			-800	$\mu\text{A}$
Low-level output current, $I_{OL}$			16			16	mA
Operating free-air temperature, $T_A$	-55		125	0		70	$^{\circ}\text{C}$

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS <sup>†</sup>	MIN	TYP <sup>‡</sup>	MAX	UNIT
$V_{IH}$	High-level input voltage		2			V
$V_{IL}$	Low-level input voltage				0.8	V
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}$ , $I_I = -12 \text{ mA}$			-1.5	V
$V_{OH}$	High-level output voltage	$V_{CC} = \text{MIN}$ , $I_{OH} = -800 \mu\text{A}$	2.4	3.4		V
$V_{OL}$	Low-level output voltage	$V_{CC} = \text{MIN}$ , $I_{OL} = 16 \text{ mA}$		0.2	0.4	V
$I_I$	Input current at maximum input voltage	$V_{CC} = \text{MAX}$ , $V_I = 5.5 \text{ V}$			1	mA
$I_{IH}$	High-level input current	$V_{CC} = \text{MAX}$ , $V_I = 2.4 \text{ V}$			40	$\mu\text{A}$
$I_{IL}$	Low-level input current	$V_{CC} = \text{MAX}$ , $V_I = 0.4 \text{ V}$			-1.6	mA
$I_{OS}$	Short-circuit output current <sup>§</sup>	$V_{CC} = \text{MAX}$ , SN54265	-20		-57	mA
		SN74265	-18		-57	mA
$I_{CC}$	Supply current	$V_{CC} = \text{MAX}$ , See Note 2		25	34	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup>Not more than one output should be shorted at a time.

NOTE 2:  $I_{CC}$  is measured with all outputs open and all inputs grounded.

switching characteristics,  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$

PARAMETER <sup>¶</sup>	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PLH}(W)$	A or B	W	$R_L = 400 \Omega$ , $C_L = 15 \text{ pF}$ , See Note 3		11.6	18	ns
$t_{PHL}(Y)$	(as applicable)	Y			11.3	18	
$t_{PHL}(W)$	A or B	W			9.8	18	ns
$t_{PLH}(Y)$	(as applicable)	Y			10.2	18	
$t_{PLH}(W) - t_{PHL}(Y)$	A or B	W with respect to Y			+0.3	$\pm 3$	ns
$t_{PHL}(W) - t_{PLH}(Y)$	(as applicable)				-0.4	$\pm 3$	

$t_{PLH}$  = propagation delay time, low-to-high-level output

$t_{PHL}$  = propagation delay time, high-to-low-level output

$t_{PXX}(W) - t_{PXX}(Y)$  = Difference in indicated propagation delay times at the W and Y outputs, respectively.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TEXAS  
INSTRUMENTS

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**SN54265, SN74265**  
**QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS**

**TYPICAL CHARACTERISTICS†**

PROPAGATION DELAY TIME DIFFERENCE  
vs  
FREE-AIR TEMPERATURE

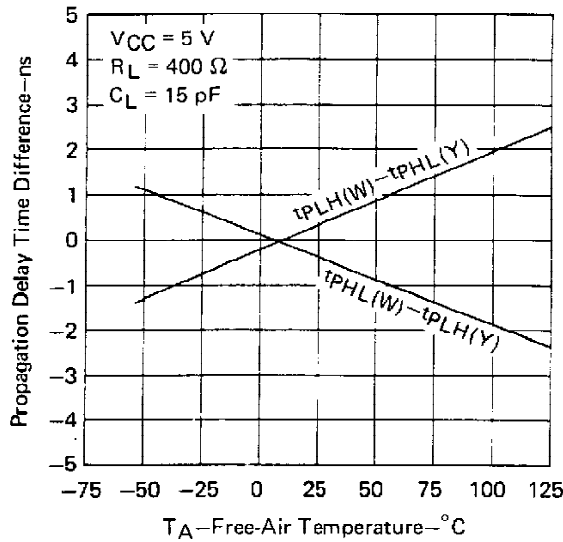


FIGURE 1

PROPAGATION DELAY TIME DIFFERENCE  
vs  
SUPPLY VOLTAGE

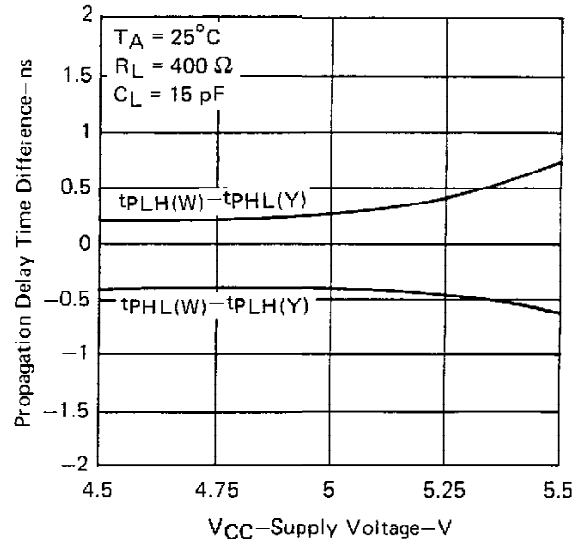


FIGURE 2

PROPAGATION DELAY TIME DIFFERENCE vs LOAD CAPACITANCE

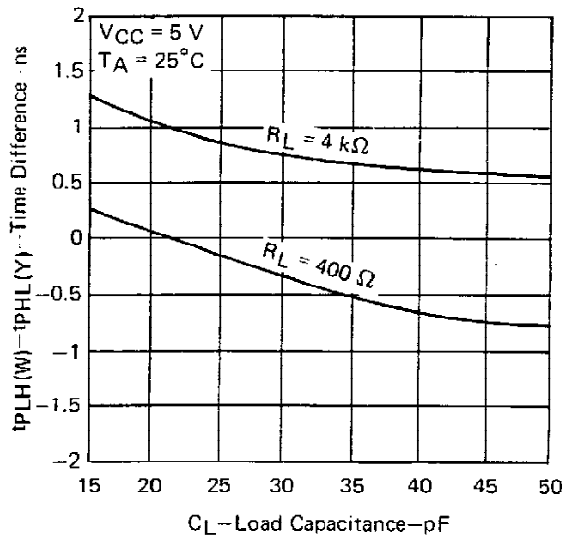


FIGURE 3

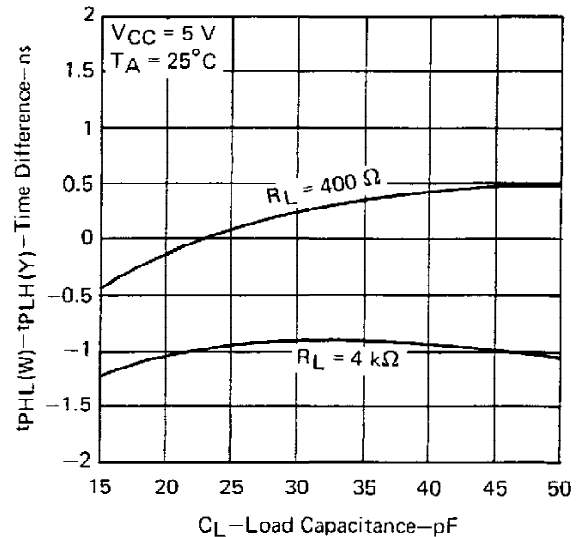
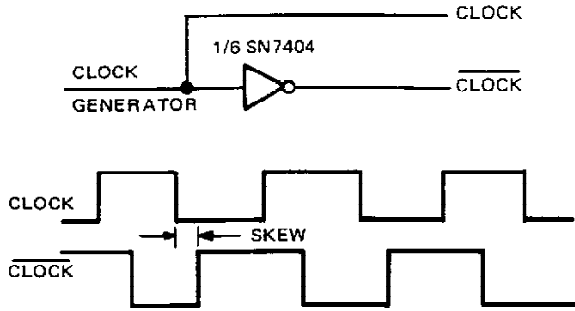


FIGURE 4

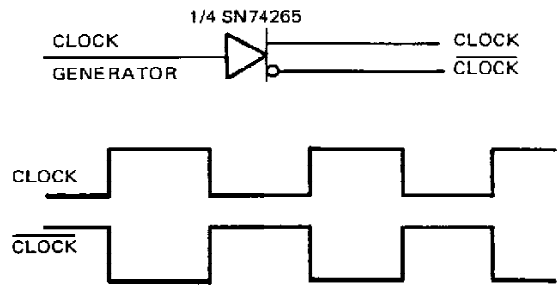
† Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable for SN54265 only.

**SN54265, SN74265  
QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS**

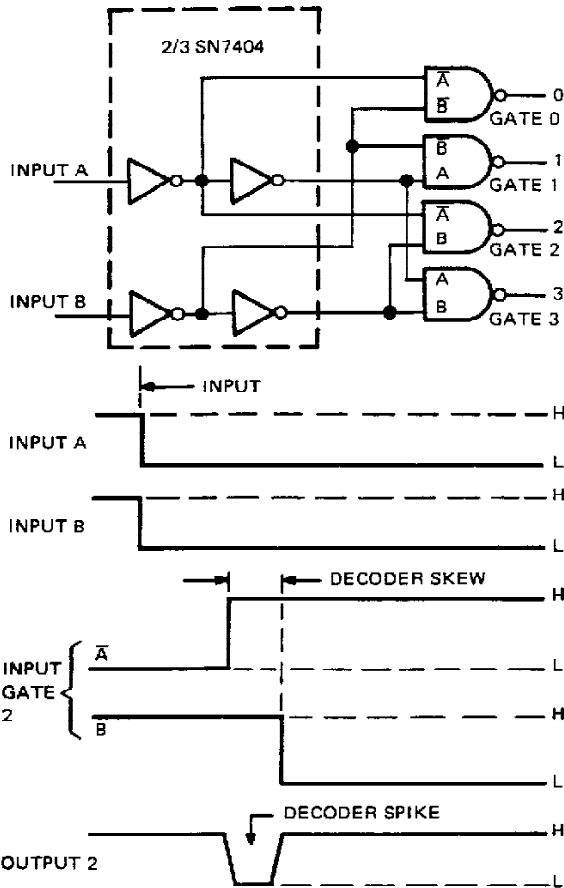
**TYPICAL APPLICATION DATA**



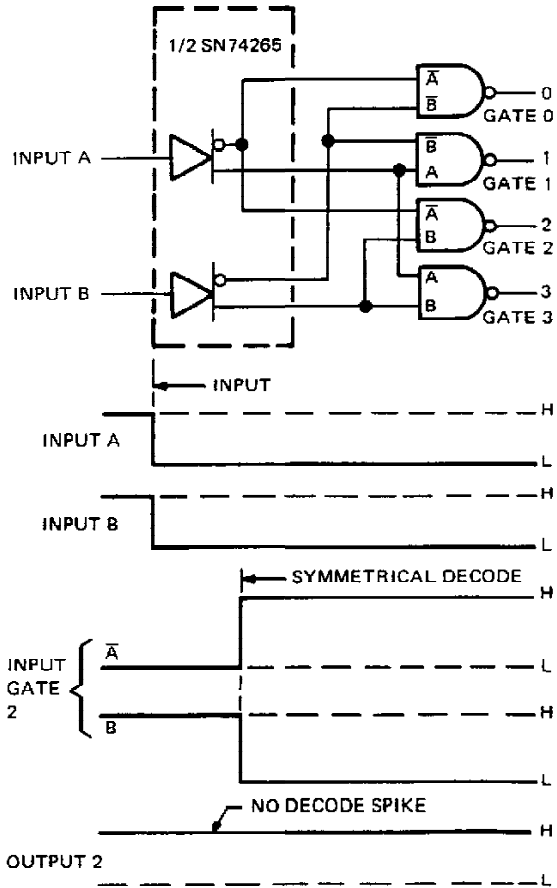
**FIGURE A – TYPICAL CLOCK/ $\overline{\text{CLOCK}}$  GENERATOR CIRCUIT**



**FIGURE B – SKEWLESS CLOCK/ $\overline{\text{CLOCK}}$  GENERATOR CIRCUIT**



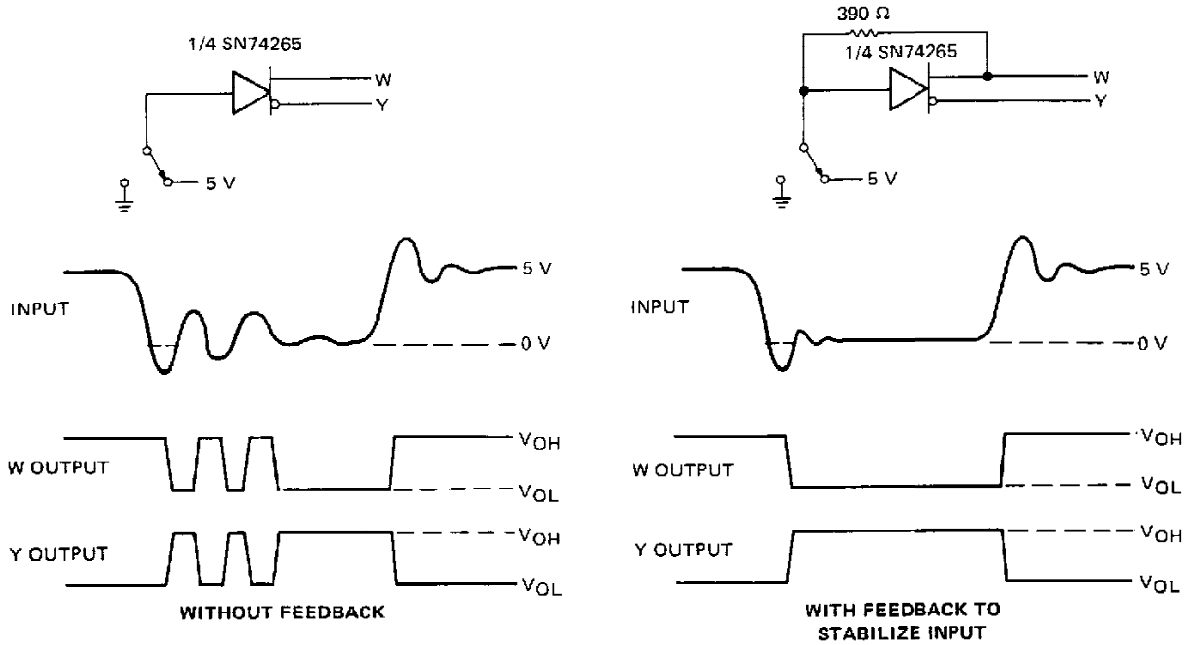
**FIGURE C – TYPICAL DECODER/CODE CONVERTER**



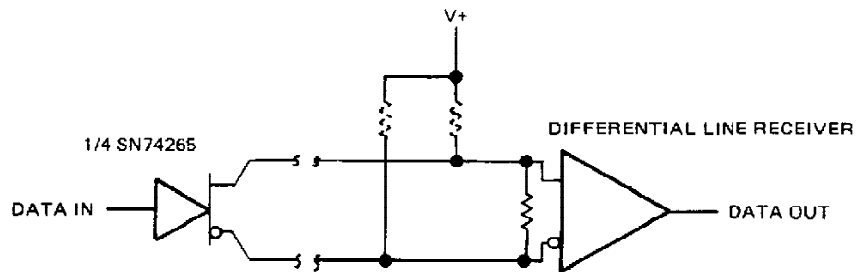
**FIGURE D – SYMMETRICAL DECODER/CODE CONVERTER**

**SN54265, SN74265**  
**QUADRUPLE COMPLEMENTARY-OUTPUT ELEMENTS**

**TYPICAL APPLICATION DATA**



**FIGURE E – SWITCH DEBOUNCER**



Noise immunity typically 3 V  
for either high level or low level data

**FIGURE F – DIFFERENTIAL LINE DRIVER**

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